

Application Report

Using the Fast Serial Interface (FSI) With Multiple Devices in an Application



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ABSTRACT

In industrial applications, it is often necessary for multiple devices to communicate with each other in a fast, low latency, and synchronized manner. One example is in a decentralized / distributed control system architecture. A new communication peripheral created for C2000™ Real-Time Control Microcontrollers (MCU), the Fast Serial Interface (FSI) can expand its reliable high-speed communication features to multiple devices in a system. This application report demonstrates how to implement a daisy-chain or star network topology using FSI. Test results are provided to validate the high-speed communication capability of FSI with different configuration methods. You can quickly verify and design FSI in different applications using the provided source code, which can be downloaded from [C2000WARE](#).

The target processors for the corresponding software include the TMS320F28002x, TMS320F28004x, and TMS320F2838x. The implementation methods and software can be applied and ported to future C2000 processors that include FSI. Example code discussed in this document can be found in the latest [C2000WARE](#) release, located within the following local directory after installation:

C:\ti\c2000\C2000Ware_<version_number>\driverlib\28xxxx\examples\fsi

The available example projects are:

- fsi_ex_daisy_handshake_lead
- fsi_ex_daisy_handshake_node
- fsi_ex_star_broadcast

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1 Introduction to the FSI Module

The FSI module is a serial communication peripheral capable of reliable and robust high-speed communications, up to 200 Mbps. Utilizing very few unidirectional signals, FSI provides a low cost way of communicating across an isolation barrier when leveraging digital isolation devices. Thus, FSI enables new ways of distributing the powerful sensing, processing, and actuation capabilities of C2000 MCUs in industrial applications, where real-time control with critical communication speed is required.

Generally, FSI can be implemented in two kinds of system conditions:

- Wired communications between MCUs that exist on the same voltage and ground planes.
- Wired communications across an isolation barrier, leveraging digital isolators (like ISO77xx), commonly used for MCUs placed on the hot-side needing to communicate with MCUs on the cold-side, or between boards with different voltage and ground planes.

There are a number of real-time systems that can benefit from the FSI peripheral. A multi-axis servo drive can be constructed with C2000 device nodes controlling each axis. Having FSI serve as the communication link, control loop information can be quickly transmitted and received between the devices to maintain precise motion control. For an example of this system see the [Distributed Multi-axis Servo Drive over Fast Serial Interface \(FSI\) reference design](#).

Additionally, with increasing global power consumption, the need for higher efficiency power supplies, in conjunction with the availability of wide bandgap GaN and SiC products, is driving the use of more sophisticated power distribution architectures. Decentralized power control solutions using C2000 MCUs can be connected and made flexible with FSI to meet these requirements. For a discussion on such power related systems see the [Distributed Power Control Architecture with Multiple MCUs Over FSI](#) white paper.

The FSI peripheral offers a broad range of features, including programmable data length, hardware managed CRC, ECC support, and more. A PING watchdog and Frame watchdog can enable automatic line-break detection. The unique delay line control feature implemented within the FSI receive module can adjust for channel-to-channel skew introduced by trace-length mismatch, transceivers, or digital isolation ICs, allowing FSI to maintain high-speed and robust communication.

The FSI consists of the independent transmitter (FSITX) and receiver (FSIRX) cores, which are configured and operated independently. Because of this, the FSI protocol does not have a notion of master and slave, unlike some other synchronous communication protocols, and allows for simultaneous full speed communications in both directions. [Figure 1-1](#) shows the CPU interface of each FSI module. Each module owns up to three signal lines: one clock and two data signals, where the second data lines, FSITXyD1 and FSIRXyD1, are optional, and can be enabled for multi-lane transmission and double the speed for data bits. Thus, at least four signal lines are needed to create 2-way point-to-point communication. Considering the timing spec for FSITX (see the device-specific data sheets referenced in [Section 7](#)), the maximum data rate of 200 Mbps can be achieved with the maximum clock of 50 MHz, using two data lines, since the data is transmitted on both edges of the clock signal. For a full overview of FSI including all features and functions available, see the device-specific Technical Reference Manual (TRM).

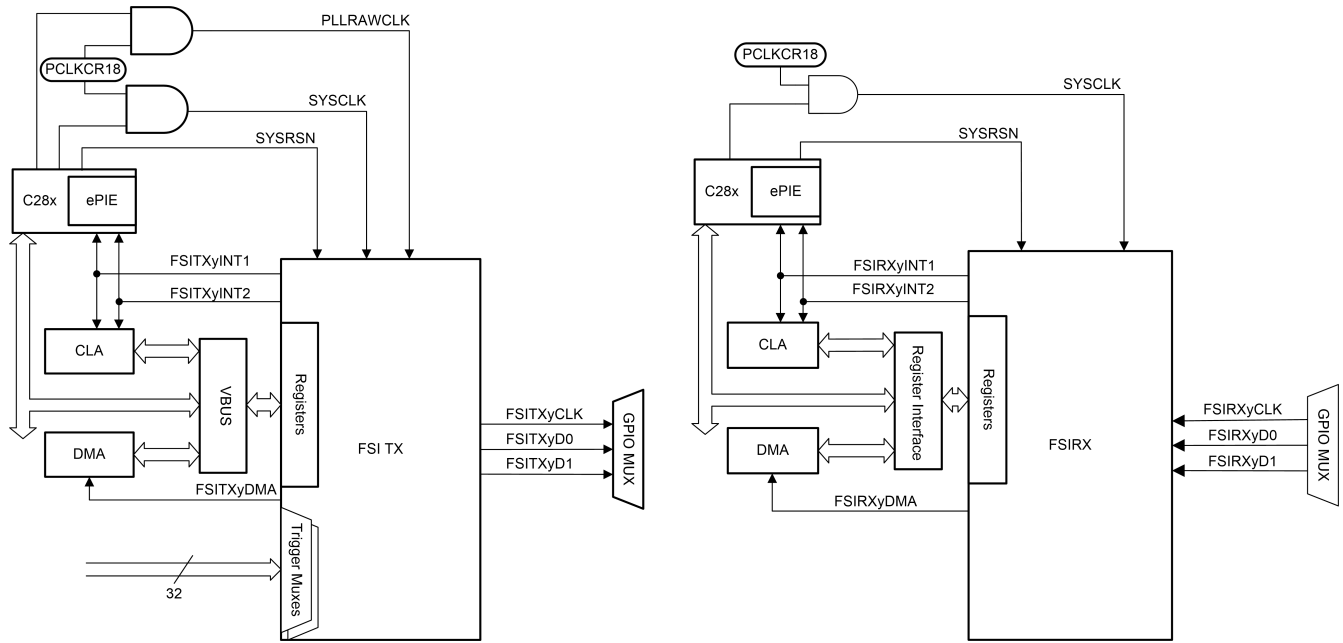


Figure 1-1. FSITX and FSIRX CPU Interface

2 FSI Applications

In terms of the trend in power electronic applications, the increasing demand for higher power levels makes multiple power modules in parallel much more popular. Examples of such applications include industrial drives, telecom rectifiers, server power supplies, on-board chargers, and so forth. Meanwhile, to achieve a complex system with high performance, multiple MCUs are commonly used and must operate in a synchronized fashion. Thus, critical data, including protection signals, sampling parameters, and even control loop data, needs to be transferred with the fastest speed and least amount of latency among multiple devices/modules. FSI will be more suitable to handle this when compared to the traditional Controller Area Network (CAN), Serial Peripheral Interface (SPI) or Universal Asynchronous Receiver/Transmitter (UART).

There are a number of communication network topologies for connecting multiple devices, each with their own benefits. A ring topology can be created by connecting multiple devices with FSI communication in a daisy-chain fashion. The advantages of a ring topology are that each device only needs one FSI transmitter and receiver and also the simplicity from a physical connection perspective. [Figure 2-1](#) shows a daisy-chain connection system for N ($N \geq 2$) node devices, where each device (index i) connects with the FSITX of device $i-1$ and FSIRX of device $i+1$.

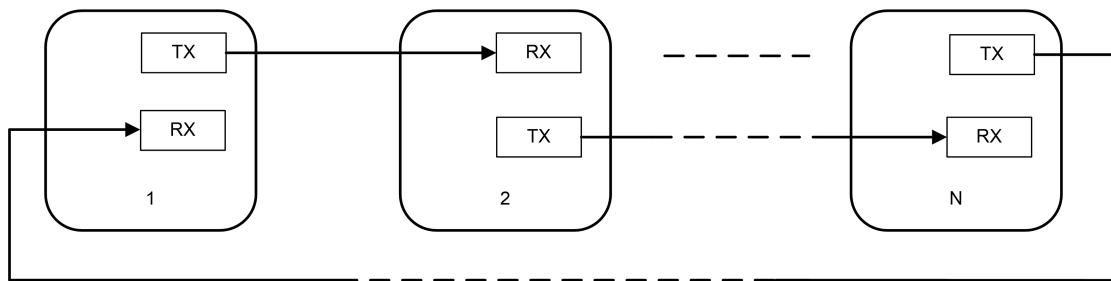


Figure 2-1. Daisy-Chain Connection Example

One disadvantage of the above daisy-chain topology is that if one device in the chain fails then the entire communication link is broken. Another downside is that devices must forward data along to the next device in the chain if the received data is intended for a subsequent device. This can add to the overall latency of when a data packet is transmitted and when the respective device in the chain receives the data.

One communication topology that solves the broken link issue and can reduce the device-to-device latency is a star topology, where several nodes connect directly to one central host device. [Figure 2-2](#) shows a star topology system with N ($N \geq 2$) node devices.

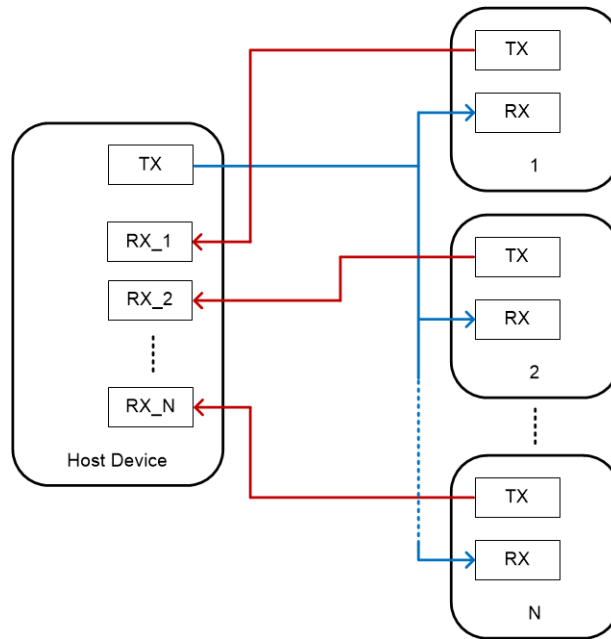


Figure 2-2. Star Topology Example

The host device's FSI transmitter is connected to the FSI receiver of each node device in order for the host to broadcast data packets to all nodes simultaneously. The node device transmitter's, on the other hand, are connected to independent receivers of the host device enabling them to send data directly back to the host at any time. This star implementation comes with a resource cost as the host needs N number of independent FSI receiver modules. The F2838x family of C2000 devices fit into the host socket with having two FSI transmitters and eight FSI receivers.

3 Handshake Mechanism

A handshake mechanism can be implemented in order to configure the devices and validate the link in an FSI communication topology. The different handshake sequences are discussed in the following sections.

3.1 Daisy-Chain Handshake Mechanism

Once the FSITX and FSIRX modules of each device have been configured, the handshake mechanism should be implemented to prepare each device in the chain before actual data transmission, since devices may power up in an arbitrary order in a real scenario.

In order to simplify the data flow, one device is assigned as the lead, working as the driver of the handshake sequence, and the other N-1 devices, within the daisy-chain loop, are assigned as nodes. Following the example in [Figure 2-1](#), Device 1 will be the lead device. It should be noted that the other N-1 node devices will share the same handshake configuration.

The handshake process can be described as follows:

1. For all devices, configure the Frame Type of FSITX as Ping Frame, and enable the receiver interrupts for Ping Frame Received event on the FSI INT1 vector to detect the incoming transmission.
2. Begin the ping loop 0:
 - a. The lead device sends the flush sequence to the second device followed by a ping frame with Tag0(0000); wait for some time. If the lead device receives a valid ping frame tag Tag0, continue to the second loop; otherwise iterate the ping loop 0 again.
 - b. The node devices enter a wait loop for a receiver interrupt. If a valid ping frame tag of Tag0 is received from the previous device, continue to the loop 1; otherwise iterate the ping loop 0 again.
3. Begin the ping loop 1:
 - a. The lead device sends a ping frame with Tag1(0001); wait for some time. If the lead device receives a valid ping frame Tag1 the handshake sequence is complete and the application can continue; otherwise iterate the ping loop 1 again.
 - b. The node devices send the flush sequence followed by a ping frame Tag0 and wait for a receiver interrupt. If a valid ping frame Tag1 is received send a ping frame Tag1 to signal the completion of the handshake sequence; or else iterate the ping loop 1 again.
4. Handshake completed.

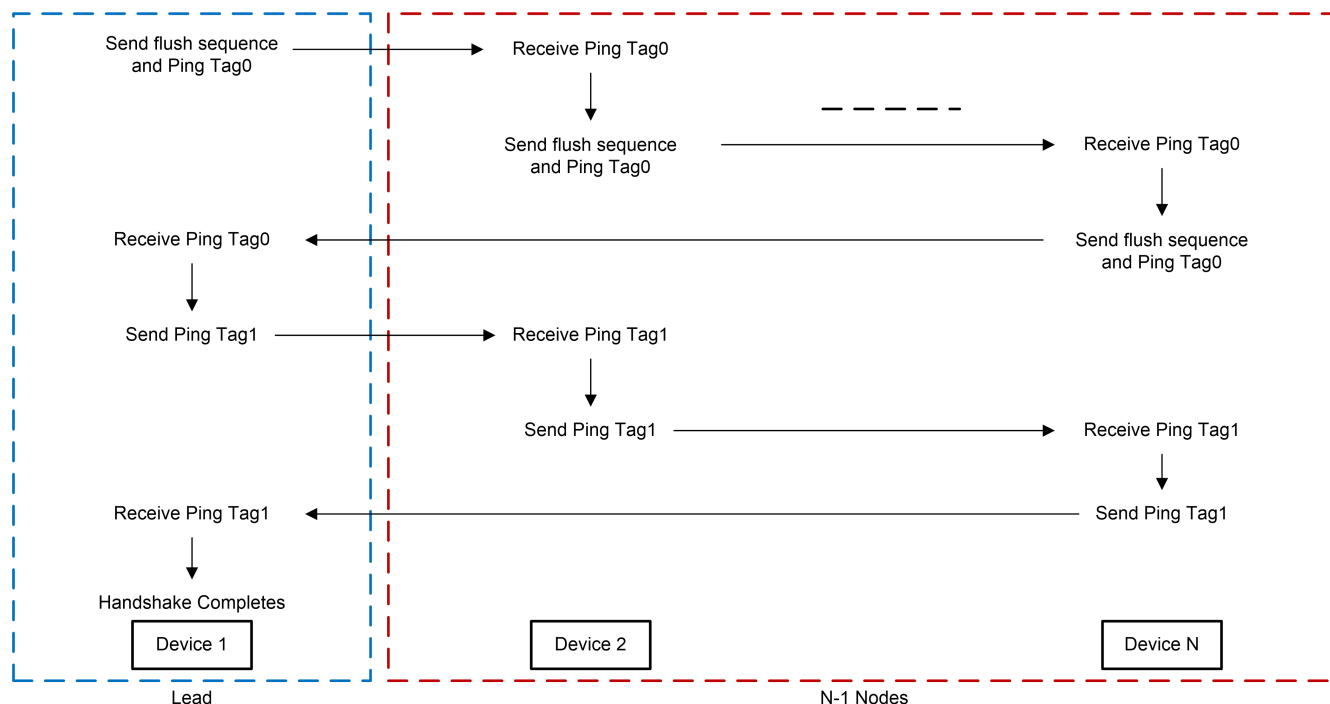


Figure 3-1. Daisy-Chain Handshake Sequence

The simplified data flow is shown in [Figure 3-1](#). Two ping loops are necessary for the daisy-chain connection handshake mechanism. Ping loop 0 has the purpose of establishing the communication path along the chain of devices and ping loop 1 acts as the acknowledgment to the nodes that the communication path is good. In ping loop 0, the node devices wait to receive a Ping Tag0 from the previous device in the chain. Once a Ping Tag0 is successfully received, it will be forwarded on to the next device in the chain. The ping loop 0 will fail if a device in the chain has not powered up or is not ready for the reception. Once ping loop 0 has succeeded, in which ping tag0 has made its way back to the lead device, ping loop 1 is initiated to inform the node devices that the handshake sequence has completed and to begin expecting actual data.

The handshake function can be found in the tested projects, with `handshake_lead()` for the lead device and `handshake_node()` for the other N-1 devices in the daisy-chain loop.

3.2 Star Handshake Mechanism

A handshake sequence very similar to what's described in [Section 3.1](#) can be applied for the star topology case. In this implementation the host, or lead, device sends broadcast pings to all of the node devices and they each respond along their independent TX paths. The lead device waits to receive ping frames from all nodes before moving on to the next step. The sequence is shown below in [Figure 3-2](#).

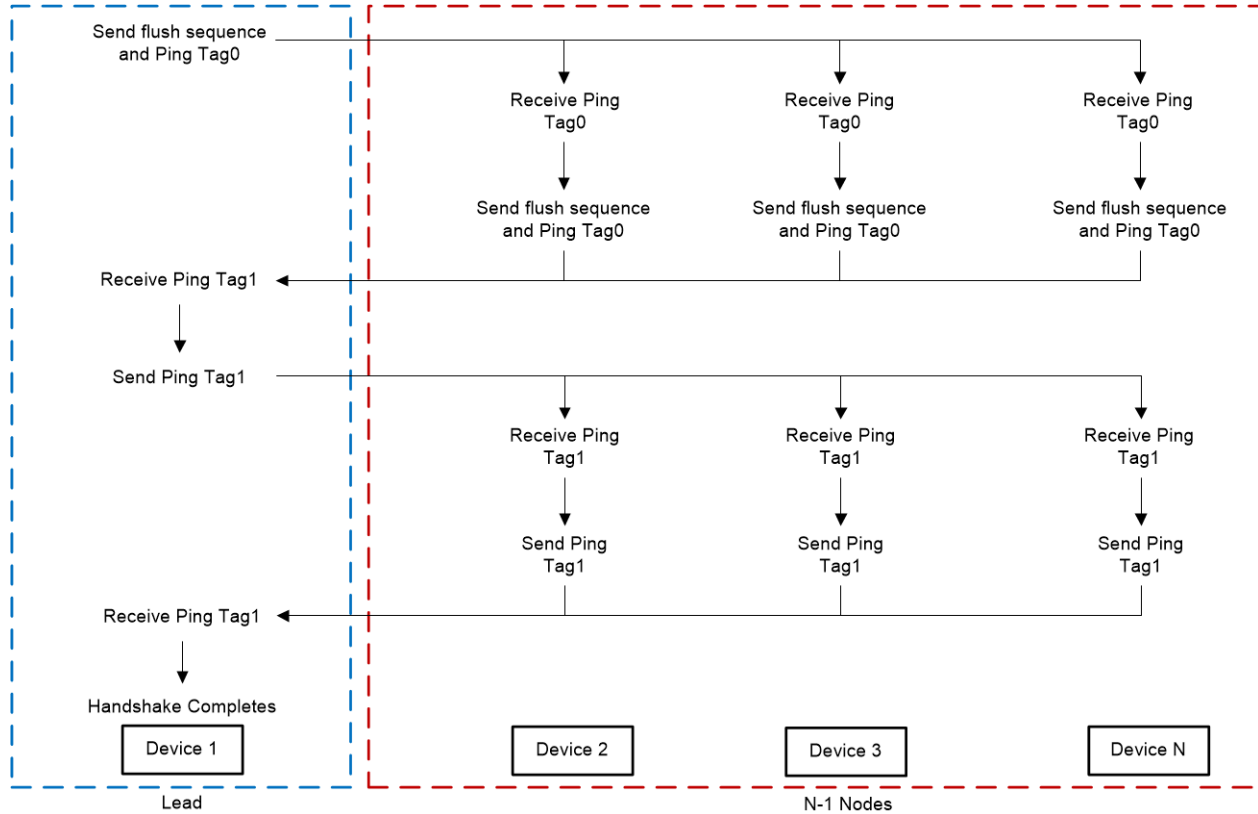


Figure 3-2. Star Handshake Sequence

4 Sending and Receiving FSI Data Frames

4.1 FSI Data Frame Configuration APIs

Several configurations are needed for data frames to be sent and received properly, including the frame type, frame tag, user data, word length, number of data lines, and writing to or reading from the data buffer. The configuration example code uses driverLib API functions for FSITX and FSIRX, defined in the fsi.h driverLib header file in C2000WARE, which are shown below. Note that the content of frame tag and user data is fully user-configurable, which can be used to differentiate which device the data received is sent from or which device it is meant for.

```
// TX setting part
FSI_setTxFrameType(FSITXA_BASE, FSI_FRAME_TYPE_NWORD_DATA);
FSI_setTxSoftwareFrameSize(FSITXA_BASE, nWords);
FSI_setTxDataWidth(FSITXA_BASE, nLanes);
FSI_setTxUserDefinedData(FSITXA_BASE, txUserData);
FSI_setTxFrameTag(FSITXA_BASE, txDataFrameTag);
// RX setting part
FSI_setRxSoftwareFrameSize(FSIRXA_BASE, nWords);
FSI_setRxDataWidth(FSIRXA_BASE, nLanes);
```

4.2 Start Transmitting Data Frames

There are three methods to trigger the data transmission, including software triggered, externally triggered (EPWMx-SOCA/B), or using the DMA. For the software triggering method, writing 1 to the TX_FRAME_CTRL.START register bit, or using the driverLib function “FSI_startTxTransmit()”, will start the transmission. If using an external trigger, like EPWMx-SOCA, once the external trigger signal occurs, the data will be sent.

Since the DMA trigger can be generated every time a data frame transmission or receiving is completed from the FSITX or FSIRX module, it provides a convenient method to transfer and store data, especially with a mass amount of data. Here a configuration example is given for the FSI communication using DMA.

TX_OPER_CTRL_LO.START_MODE must be set to 0x2, which means writing to frame tag/user data fields can trigger the transmission and then enables a DMA event on FSITX:

```
FSI_setTxStartMode(FSITXA_BASE, FSI_TX_START_FRAME_CTRL_OR_UDATA_TAG);
FSI_enableTxDMAEvent(FSITXA_BASE);
```

Two consecutive DMA channels are needed to fill the transmit buffer and frame tag/user data fields, respectively. Using the two channels in sequence allows for the transmission to start right after the frame tag and user data are set, as configured in the TX_OPER_CTRL_LO.START_MODE register bits. In the example code, DMA CH1 and DMA CH2 are used. Another important point is that the wrap control must be enabled for data of more than 16 words, since the FSI transmit buffer is a 16-word circular buffer.

```
DMA_configWrap(DMA_CH1_BASE, DMA_TRANSFER_SIZE_IN_BURSTS, 0, dest_WrapSize, 0);
```

Here, dest_WrapSize represents the number of bursts to be transferred before a wrap of the destination address, so dest_WrapSize should be 16/ nWords. This can be implemented such that the transmit buffer is continuously fed by the DMA, which is triggered by FSITX in return, with DMA Continuous Mode enabled.

The FSIRX is configured very similarly to the FSITX, except for that there is no order requirement for the DMA channels for RX buffer and tag and user data. In the example projects, DMA CH3 and DMA CH4 are used.

5 Daisy-Chain Topology Tests

In order to demonstrate the communication speed and different configurations for FSI, daisy-chain connections for two device and three device configurations have been tested and validated. The test hardware utilized is composed of multiple [F280025C ControlCARD Evaluation Modules](#) and [TMDSFSIADAPEVMs](#).

Note

These same tests can be performed with [LAUNCHXL-F280049Cs](#) and [TMDSFSIADAPEVMs](#) as well with similar hardware setups.

The tested example projects can be found within the C2000WARE download. All test results were collected using optimization level 2, configured within Code Composer Studio™ (CCS). Changing the optimization level may yield different results. An overall description of the tested projects is shown in [Table 5-1](#). For better understanding, a general software flow chart with different project settings is shown in [Figure 5-1](#).

Table 5-1. Example Projects Description - Daisy-Chain

Project	Description	Settings
fsi_ex_daisy_handshake_lead	Project for the lead device in the daisy-chain loop.	① [#define FSI_DMA_ENABLE 0] represents FSI communication using CPU control.
fsi_ex_daisy_handshake_node	Project for the N-1 other devices (N>=2) in the daisy-chain loop.	② [#define FSI_DMA_ENABLE 1 && #define TX_DMA_TRIGGER_ENABLE 0] represents FSI communication using DMA control, and using software to trigger DMA for the transmitted data (manually). ③ [#define FSI_DMA_ENABLE 1 && #define TX_DMA_TRIGGER_ENABLE 1] represents FSI communication using DMA control, and enabling FSITX to trigger DMA for the transmitted data.

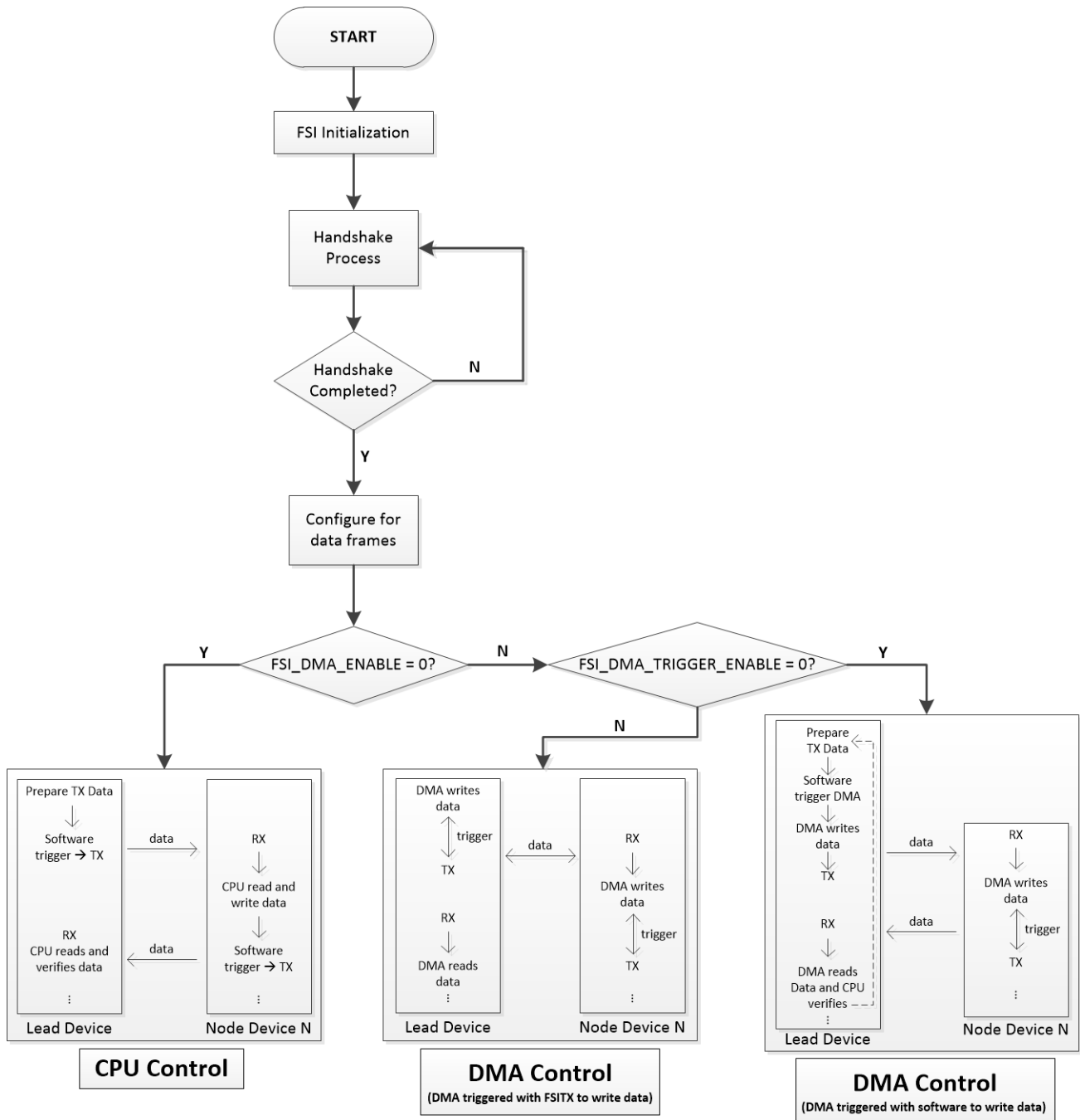


Figure 5-1. Software Flow Chart With Different Project Settings

5.1 Two Device FSI Communication

For a minimal daisy-chain connection test, a system of two [F280025C ControlCARD Evaluation Modules](#) and [TMDSFSIADAPEVMs](#) are used as shown in [Figure 5-2](#). The comparison of the communication speeds for both CPU control and DMA control is provided in the following sub-sections.

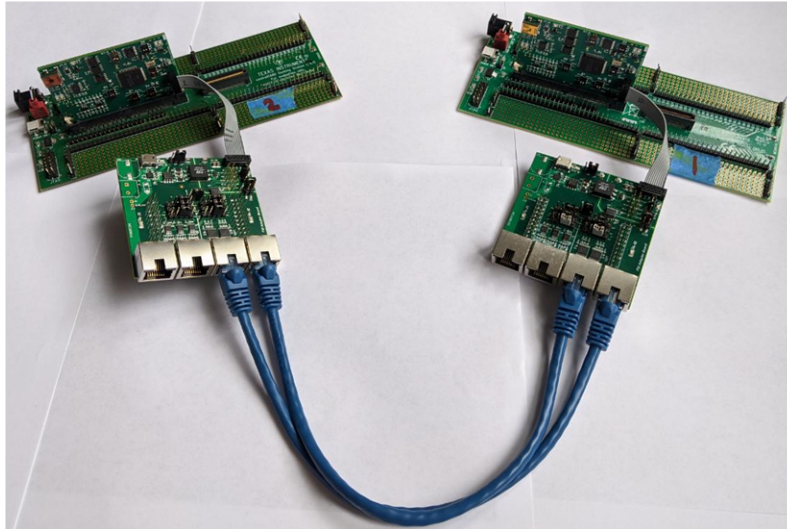


Figure 5-2. Test Platform for Two Device Communication

5.1.1 CPU Control

- **Test condition:**

Device 1 sends data -> Device 2 receives data -> Device 2 CPU moves RX data to TX buffer and registers -> Device 2 triggers FSI TX with SW which forwards the received data back to Device 1 -> Device1 receives data back and the CPU verifies it matches the originally sent TX data.

- **Test case:**

Data length of 8 words, two data lines, TXCLK = 50 MHz, with Setting ① ([Table 5-1](#)) enabled.

In the test, GPIOs are toggled within software when specific events occur during the communication and measured using an oscilloscope to obtain the respective timing data. In [Figure 5-3](#), the green signal represents the GPIO toggling of Device 1 (Lead device) and the magenta signal represents the GPIO toggling of Device 2 (Node device).

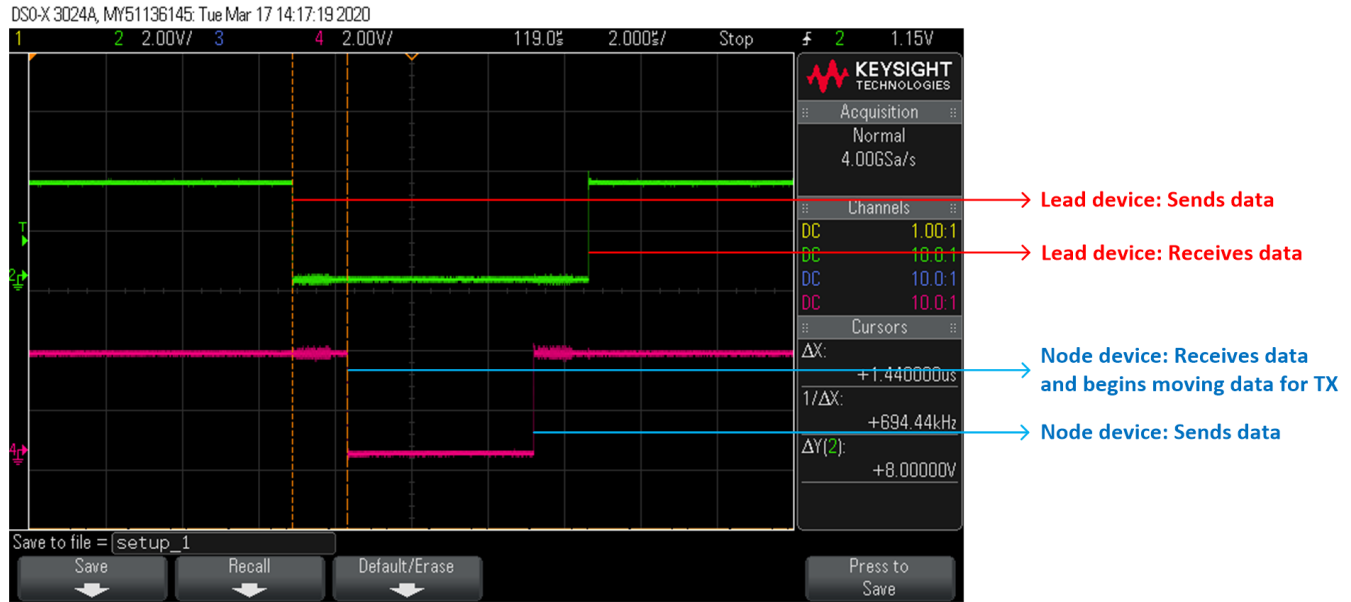


Figure 5-3. Data Transmission Test Using CPU Control

From the results shown in [Figure 5-3](#), the time obtained for the data transmission is $\sim 1.4 \mu\text{s}$. In order to calculate the transmission speed, the total data length should be considered. [Table 5-2](#) shows the general structure of a data frame, which can be divided into two parts: effective data bits and overhead bits.

- **Effective Data Bits:** Includes the 8-bit User Data, 16-bit Data Words, and 8-bit CRC fields
- **Overhead Bits:** Includes the Preamble, SOF, Frame Type, EOF, and Postamble fields

Therefore, the ideal transmission time for 8 words can be derived theoretically, as shown in [Table 5-3](#).

It should be noted that since two data lines only work for effective data bits, one FSITXCLK cycle delivers 4 effective data bits, while one FSITXCLK cycle only delivers 2 overhead bits. Thus, with a total 48 FSITXCLK cycles for 8 data words, the transmission time can be calculated as shown in [Equation 1](#).

$$(\text{FSITXCLK cycles}) / (\text{FSITXCLK frequency}) = 48 / (50 \text{ MHz}) = 0.96 \mu\text{s} \quad (1)$$

Therefore, the theoretical transmission speed is 175 Mbps ($168/0.96 \mu\text{s}$), while the speed from the test is 120 Mbps with $1.4 \mu\text{s}$ transmission time, due to the fact that the tested transmission time includes entering the ISR (to toggle an IO pin), delay introduced by isolators, transceivers, cables, and so forth. If changing to one data line, the theoretical transmission speed is 100 Mbps, while the test speed is 80 Mbps with a transmission time of $2.1 \mu\text{s}$.

Another finding from [Figure 5-3](#) is that moving data from the FSIRX buffers to the FSITX buffers in the node device takes some time, approximately $4.9 \mu\text{s}$ using the FSI driverLib functions. This will be a key factor that distinguishes DMA control as shown in the next section.

Note

The time to move data between the FSI buffers and registers can be optimized by writing to and reading from the FSI registers directly instead of using the provided driverLib functions.

Table 5-2. Data Frame Structure

IDLE	Preamble	SOF	Frame Type	User Data	Data Words	CRC	Frame Tag	EOF	Postamble	IDLE
	1111	1001	0011	8 bits	N words	8 bits	4 bits	0110	1111	

Table 5-3. Calculated Transmission Time for 8 Words

Effective Data Bits (bits)	Overhead Bits (bits)	Total Length (bits)	FSITXCLK Cycles for Effective Data Bits (cycles)	FSITXCLK Cycles for Overhead Bits (cycles)	Total Data Transmission Time (us)
144	24	168	36	12	0.96

5.1.2 DMA Control

- Test condition**

Device 1 sends data -> Device 2 receives data -> Device 2 DMA moves RX data to TX buffer and registers -> Device 2 triggers TX when TX_FRAME_TAG_UDATA FSI register is written to which forwards the received data back to Device 1 -> Device 1 receives data back -> Device 1 DMA moves RX data to memory -> CPU verifies data in memory matches the originally sent TX data.

- Test case**

Data length of 8 words (8 words per burst, 1 burst per transfer), two data lines, TXCLK = 50 MHz, with Setting ② (Table 5-1) enabled.

In this test, DMA interrupts from CH2 and CH4 are enabled to trigger at the end of a transfer in the lead device, which means that interrupts occur every time data has been copied from memory to the FSITX buffer (CH2) or data has been transferred out of the FSRX buffer to a location in memory (CH4). In the node device, the DMA channels are configured to transfer received data from the RX buffers and registers to the TX buffers and registers anytime an FSI data frame is received, ultimately forwarding the data back to the lead device. Therefore the node device only has one DMA interrupt enabled while the lead device has two. With GPIOs toggling in the DMA ISRs, Figure 5-4 shows the test results of FSI communication using DMA control.



Figure 5-4. FSI Communication Using DMA Control

It should be noted that the time of 1.86 μ s shown includes the time for the lead device to transmit the data frame, the node device to move RX data to the TX buffer / registers, entering of the ISR, and toggling the GPIO. According to the DMA pipeline timing requirements (See device specific TRM referenced in [Section 7](#) for more info), the time for moving data of 9 words (8 words data + 1 word of user data and frame tag) using 2 channels can be calculated as shown in [Equation 2](#).

$$(9 \times 3 \text{ cycles/word} + 2 \text{ cycles}) \div (100 \text{ MHz}) = 0.29 \mu\text{s} \quad (2)$$

Thus, considering other delay times, the actual transmission time is almost aligned with the former test result (1.4 μ s) using CPU control. Also, it should be highlighted that utilizing the DMA in this case drastically saves the time for transferring received data, especially in an application with mass data transmissions..

Further test results are given in [Table 5-4](#), for the comparison of using CPU control and DMA control of FSI. With overhead bits being fixed in the FSI data frame structure, it is beneficial to use a longer data length to maximize the effective data throughput.

Table 5-4. Comparison of Using CPU Control and DMA Control in FSI for Two Devices

	FSITXCLK (MHz)	# of Data Lines	Data Length (16-bit words)	Transmission Time (μ s) ⁽¹⁾	Buffer Data Move Time (μ s) ⁽¹⁾	Theoretical Transmission Speed (Mbps) ⁽²⁾	Test Transmission Speed (Mbps)
CPU Control	50	2	8	1.4	4.9	175	120
	50	2	16	2.1	8.3	185	141
	50	1	8	2.1	4.9	100	80
	10	1	8	8.9	4.9	20	18.9
DMA Control	50	2	8	1.9		/	/
	50	2	16	3.0		/	/
	50	1	8	2.6		/	/
	10	1	8	9.3		/	/

(1) Measured times are rounded to the nearest 0.1 μ s.

(2) Accounts for FSI frame overhead bits being transmitted on both lines in the two data lines cases.

There may be cases where FSI communication may need some additional robustness and noise immunity and for that reason a lower clock frequency has also been tested. The FSI protocol is designed to communicate only when there is data exchange. This helps to reduce power and over all EMI in the system. Additionally, lower FSI clock frequencies and half-duplex communication could improve overall system level EMI performance while continuing to provide higher throughput than generic serial ports at the same operating frequencies. Generally, it is best to use a twisted pair or shielded wire per line for board-to-board connections, while on board FSI signal trace lengths should match and have special care taken in the layout to enhance noise immunity.

In the tests performed there are isolation and differential transceiver devices being used on the [TMDSFSIADAPEVM](#) boards, which could introduce channel-to-channel skew. In a real world application that utilizes these same or similar devices, and/or varying signal trace lengths, the integrated skew compensation block within the FSI receiver module can be used to manage the skew that may occur between the clock and data signals. For more information on this topic, see [Fast Serial Interface \(FSI\) Skew Compensation](#).

5.2 Three Device FSI Communication

Based on the test and comparison results given in [Section 5.1](#), FSI communication for three devices has also been investigated. The test platform used is shown in [Figure 5-5](#).

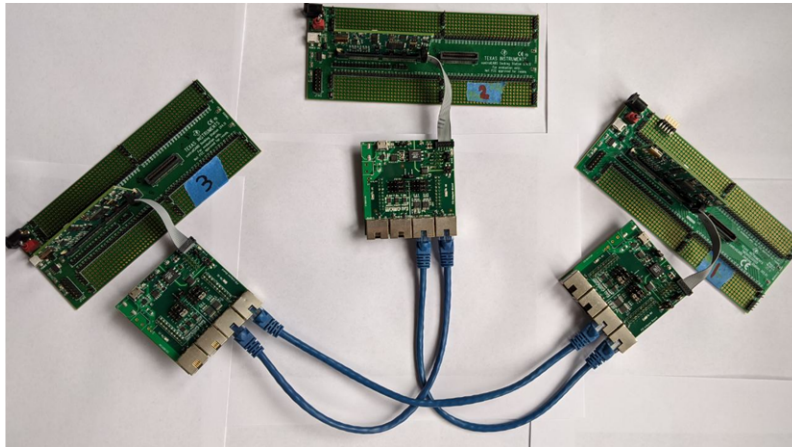


Figure 5-5. Test Platform for Three Devices Communication

Due to the nature of a daisy-chain connection, data will need to pass through a number of devices for the transmission from the first device to reach the last device. Therefore, to reduce latency it is important to make the data handling and forwarding time in each device as short as possible, especially when there are a number of devices in a connection loop. From the conclusion drawn in [Section 5.1](#), to avoid having the CPU spending too much bandwidth moving data, it is recommended to use the DMA to serve FSI communication. The following tests utilize the same software discussed in [Section 5](#) for the lead and node devices.

- **Test condition**

Device 1 sends data -> Device 2 receives data -> Device 2 moves RX data to TX buffer and sends data to Device 3->.....-> Device 3 moves RX data to TX buffer and sends data to Device 1 -> Device1 receives data and verifies the data matches the originally sent TX data.

- **Test case**

Data length of 8 words, 1 data line, TXCLK = 50 MHz, with setting ① for CPU control case and ② for DMA control case ([Table 5-1](#)) enabled.

In the tests, GPIOs are toggled within software when specific events occur during the communication and measured using an oscilloscope to obtain the respective timing data. In the figures below, the green signal represents the GPIO toggling of Device 1 (Lead device), the blue signal represents the GPIO toggling of Device 2 (Node device), and the magenta signal represents the GPIO toggling of Device 3 (Node device).

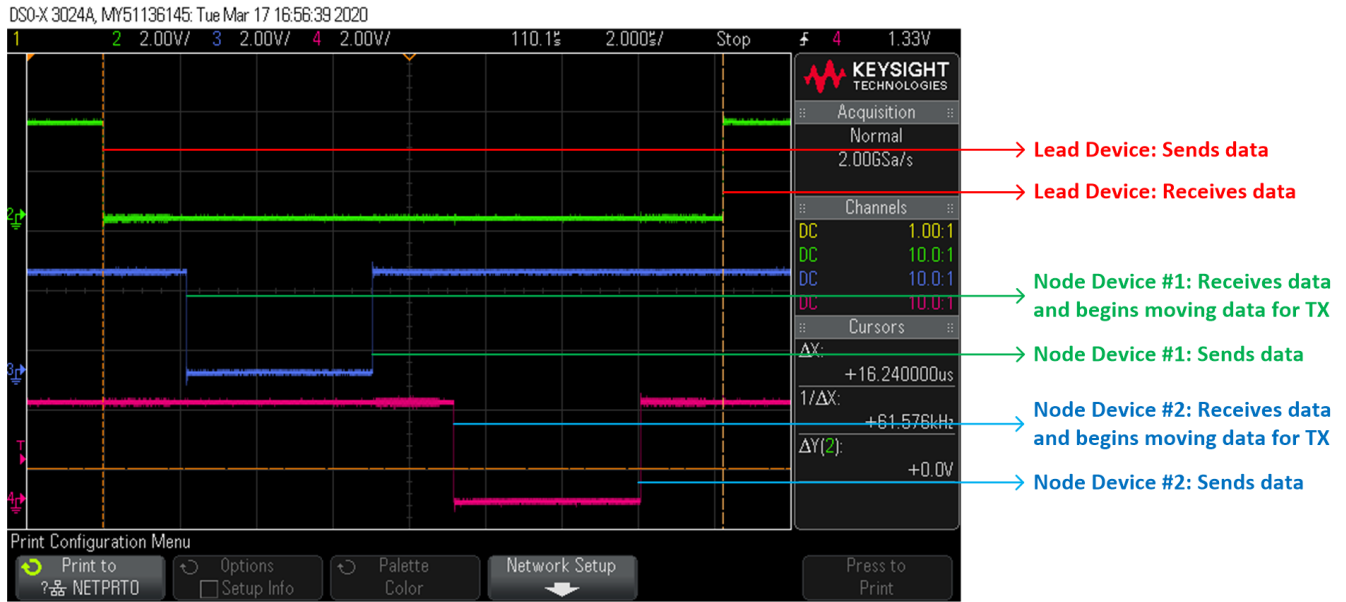


Figure 5-6. FSI Communication With CPU Control Among Three Devices

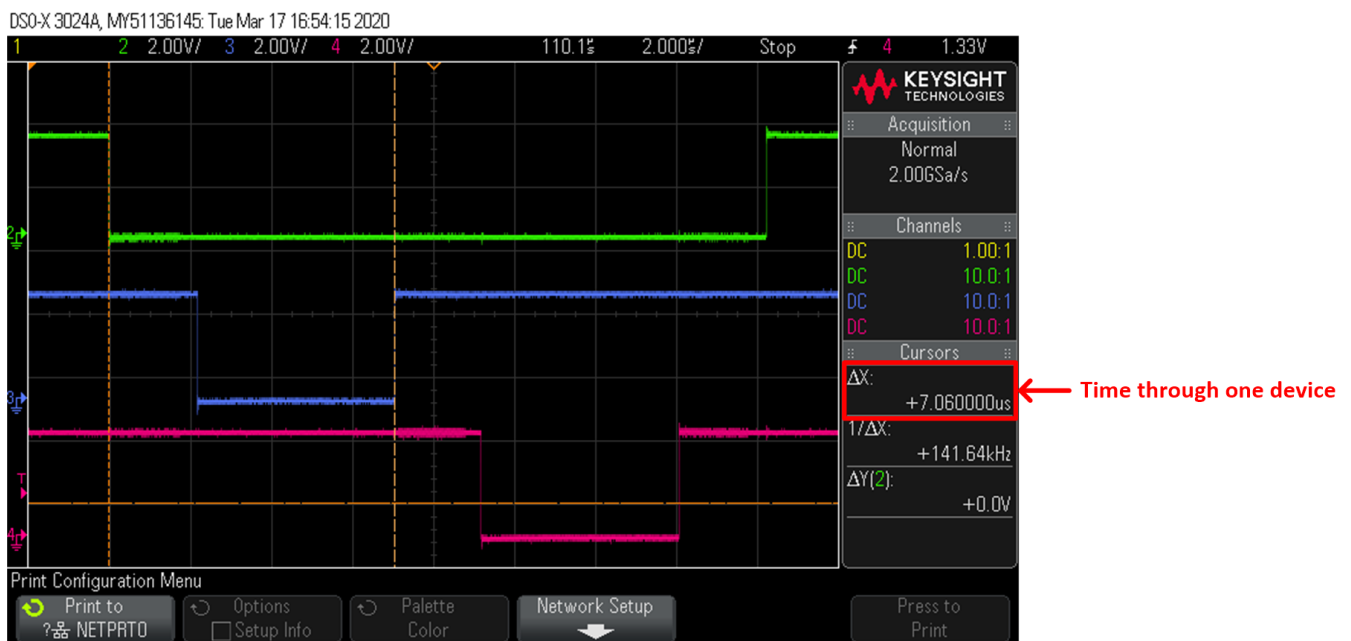


Figure 5-7. Time of Data Going Through One Device - CPU Control

For the CPU control case, the time needed for the data transmission to complete the three device daisy-chain loop is 16.2 μ s, as shown in Figure 5-6. This time will increase by 7.1 μ s for each device added to the daisy-chain connection system, as shown in Figure 5-7. The 7.1 μ s increased time per device includes the time for transmission and moving RX data to the TX buffer and registers.

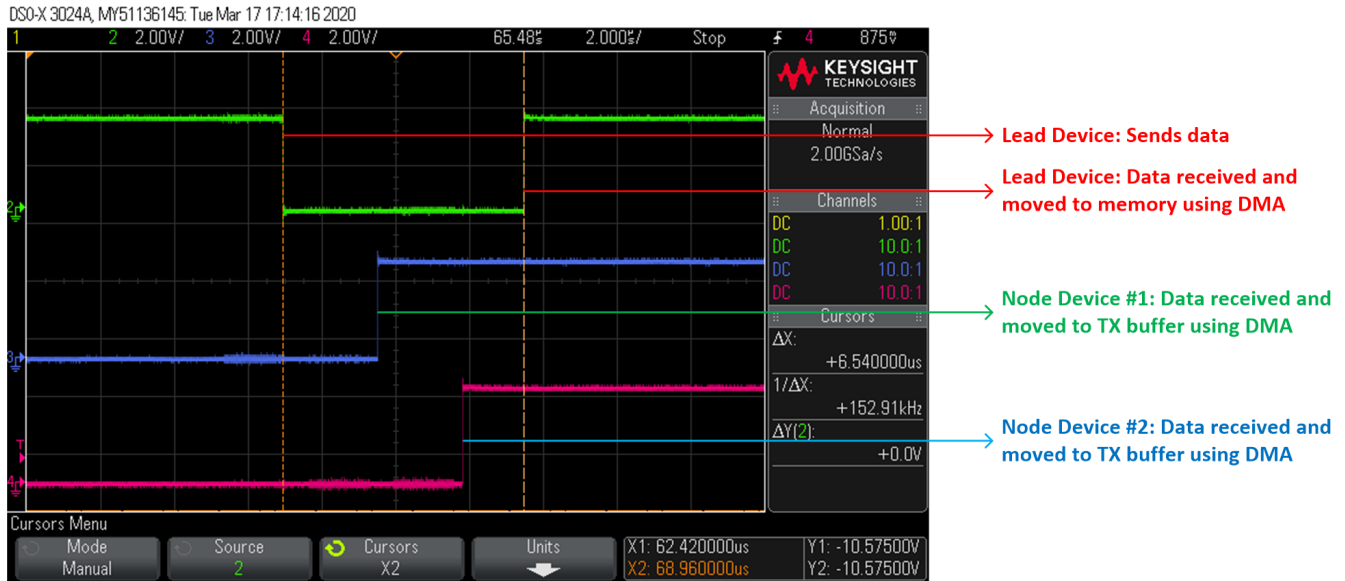


Figure 5-8. FSI Communication with DMA Control Among Three Devices

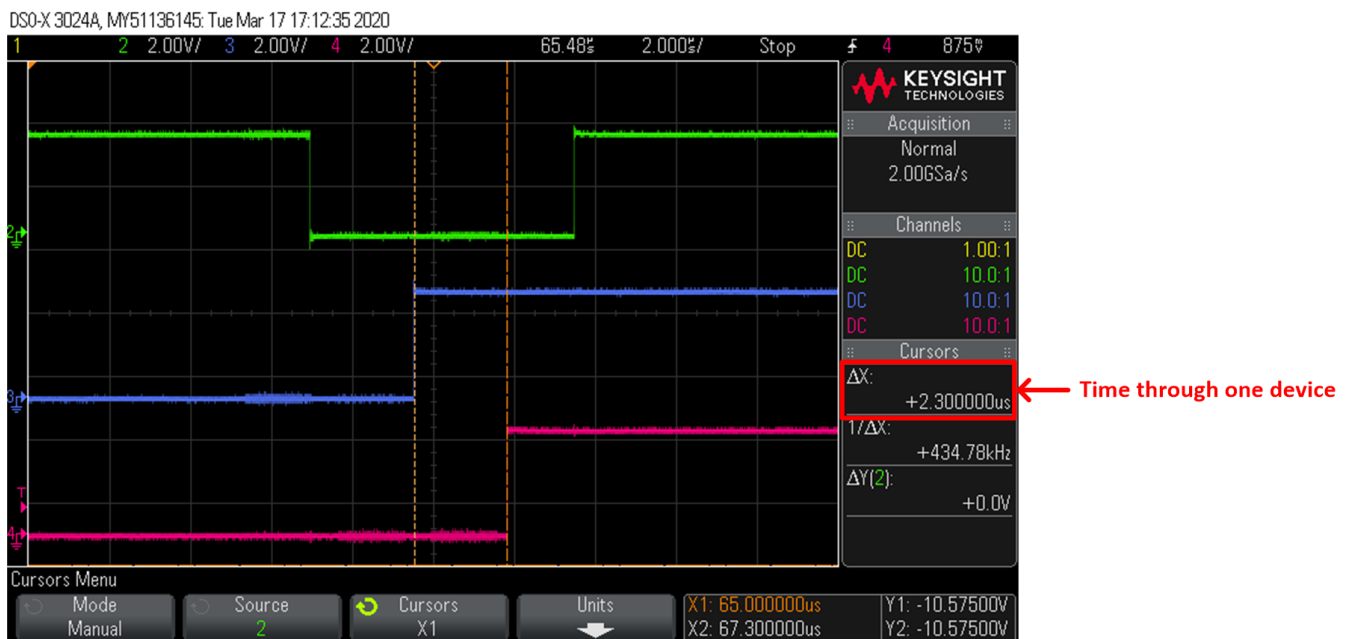


Figure 5-9. Time of Data Going Through One Device - DMA Control

For the DMA control case, the time needed for the data transmission to complete the three device daisy-chain loop is 6.5 μ s, as shown in Figure 5-8. This time will increase by 2.3 μ s for each device added to the daisy-chain connection system, as shown in Figure 5-9. The 2.3 μ s increased time per device includes the time for transmission and moving RX data to the TX buffer and registers.

Further test results can be found in [Table 5-5](#).

Table 5-5. Comparison of Using CPU Control and DMA Control in FSI Among Three Devices

	FSITXCLK (MHz)	# of Data Lines	Data Length (16-bit words)	Time of data going through one device (µs)	Time of the full connection loop - 3 devices (us)
CPU control	50	1	8	7.1	16.2
	50	1	16	11.8	26.8
DMA control	50	1	8	2.3	6.5
	50	1	16	4.0	11.8

6 Star Topology Tests

The star topology over FSI application example demonstrates a different kind of communication topology, showcasing how a central host device can receive information from multiple node devices at the same time rather than wait for packets to be forwarded through subsequent devices, like in the daisy-chain example. The advantages and disadvantages of the star topology are discussed in [Section 2](#).

The defining requirements of the star implementation provided are hardware related, i.e. host device TX needing to have multi-drop functionality to each node, and MCU resource related, i.e. host device needing N number of RX instances. From a software perspective the central host device uses a new *star_broadcast* project while the N node devices use the same node device software utilized in the daisy-chain tests, details provided in [Table 6-1](#).

Table 6-1. Software Example Projects - Star Topology

Project	Description	Supported Devices
fsi_ex_star_broadcast	Project for central host device in the star network	F2838x
fsi_ex_daisy_handshake_node	Project for N number of node devices in the star network	F28002x, F28004x, F2838x

The software flow of the *star_broadcast* project is similar to that of the lead device CPU Control daisy-chain project discussed in [Section 5](#). The handshake mechanism will be slightly different as shown in [Section 3.2](#). Upon completion of the handshake, the central host device will transmit a broadcast data frame to all of the node devices connected to its FSITX. The host will then wait to receive the data frame back from all connected node devices and then validate that each received frame matches the originally transmitted one, after which it will prepare and send a new data frame.

By default, the *star_broadcast* project has pre-made configurations for FSI RX instances A, B and C of the device. Each instance can be configured by setting the individual pre-processor directives below to "1". Additional FSI RX instances can be added if they are available on the host device.

```
//
// Enable FSI RX Instances
//
#define FSI_RXA_ENABLE    1
#define FSI_RXB_ENABLE    0
#define FSI_RXC_ENABLE    1
```

Timing measurements of the star topology will be very similar, if not the same, as those collected in the previous daisy-chain tests. Therefore the data provided in [Table 5-4](#) can be utilized for this purpose.

7 References

- Texas Instruments: [TMS320F28002x Microcontrollers Data Sheet](#)
- Texas Instruments: [TMS320F28002x Microcontrollers Technical Reference Manual](#)
- Texas Instruments: [TMS320F2838x Microcontrollers Data Sheet](#)
- Texas Instruments: [TMS320F2838x Microcontrollers Technical Reference Manual](#)
- Texas Instruments: [TMS320F28004x Microcontrollers Data Sheet](#)
- Texas Instruments: [TMS320F28004x Microcontrollers Technical Reference Manual](#)
- Texas Instruments: [TIDM-02006 Distributed multi-axis servo drive over fast serial interface \(FSI\) reference design](#)
- Texas Instruments: [Distributed Power Control Architecture With Multiple MCUs Over FSI](#)
- [TMDSFSIADAPEVM: FSI Adapter Board](#)
- [F280025C ControlCARD Evaluation Modules](#)

8 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from September 00, 2020 to October 12, 2020 (from Revision B (September 2020) to Revision C (October 2020))

	Page
• Updates were made in the Abstract.....	0
• Updated the numbering format for tables, figures and cross-references throughout the document.....	3
• Update was made to Section 1	3

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